Applicabl	e standard										
Operating			-35°C to +85°C(Note 1)		Storage			-10°C to +60°C(Note 3)			
Rating	temperature range Operating humidity range		20 % to 80 % (Note 2)		Ste	mperature ra orage	-		40 % to 70 %(N	,	
				\ \	_	midity range	e		4 4		
	Voltage		150 V AC (DC)		Current			1 A			
	Applicable Connector		DF13-*DS-1.25C			Applicable Contact			DF13(G)-2630SCF DF13-3032SCF		
			Spe	cificat	ior	าร					
lt	em		Test method			Requirements				QT	A
Construction											
General examination		Visually and by measuring instrument.				According to drawing.					Х
Marking		Confirmed visually.									Х
Electric o	characteris										
Contact resistance		100 m A (DC or 1000 Hz).				30 mΩ MAX.				Х	-
Insulation resistance		100 V DC.			500 MΩ MIN.				Х	_	
Voltage proof		500 V AC for 1 min.			No flashover or breakdown.				X	- 1	
Mechani	cal charac	teristics									
Mechanical of		30 times insertions and extractions.				(1) Contact resistance: 30 m Ω MAX.				V	
						 No damage, crack or looseness of parts. 				Х	_
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.				 No electrical discontinuity of 1µs. No damage, crack or looseness of parts. 				Х	-
Shock		490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.									1 –
Environn	nental cha										
Rapid chang			ure -55 \rightarrow 15 to 35 \rightarrow +85 \rightarrow 1	5 to 35 °c			tact resis	tance	e: 30mΩ MAX.		
temperature		Time $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to 3 min. Under 5 cycles.				 ② Insulation resistance: 500 MΩ MIN. ③ No damage, crack or looseness of parts. No deformation of case of excessive looseness of the terminals. 				X	_
Damp heat		Exposed at 40 \pm 2 °c, 90 to 95 %, 96 h.			x					<u> </u>	
(Steady state)											
Resistance to soldering heat		 Reflow soldering Reflow area ≫ 250°C MAX 10 sec MAX 230°C MIN 60 sec MAX Preheating area ≫ 170°C to 190°C 60 sec to 120 sec Put through in reflow furnace twice, leave in ambient temperature and humidity for 1 hour. Manual soldering Soldering iron temperature :300°C, Soldering time : 3sec. No strength on contact. 								X	
Solderability			Soldered at solder temperature, 245°c for insertion duration, 3sec.			Solder shall cover a minimum of 95 % of the surface being imm				Х	-
Note 2:No cor Note 3:Apply t after p	e the temperatur ndensing to the condition o ocb on board, op	of long term s erating temp	storage for unused products befo erature and humidity range is ap	plied for inte	rim s	storage duri			n.		<u> </u>
Count Description			n of revisions Desi		ligned			Checked	Date		
Unless otherwise specifid			d , refer to IEC 60512.			٨٥	proved HS. OKAWA		16 05	16	
						Approved Checked Designed					
									TS. FUKUSHIMA		
								YK. YAMAGUCHI	16.05.14		
					Drawn			MI. SAKIMURA			
						Drawing no.			ELC-367982-25-00		
HRS ——		Specification sheet			Ρ	art no.		DF	13EA-*DP-1.25V(25)	
		Hirose	se electric co., ltd.			ode no.	CL536		⚠	1/1	
ODM LIDO											_